



Change in Packaging for the FX5S CPU Modules

■Date of Issue

February 2023

■Relevant Models

FX5S-30MR/ES, FX5S-30MT/ES, FX5S-30MT/ESS, FX5S-40MR/ES, FX5S-40MT/ES, FX5S-40MT/ESS, FX5S-60MR/ES, FX5S-60MT/ES, FX5S-60MT/ESS

Thank you for your continued support of Mitsubishi Electric micro programmable controllers, MELSEC iQ-F series. This technical bulletin informs you that the packaging and the size of boxes for the MELSEC iQ-F series FX5S CPU modules will be changed.

There is no impact on the general specifications, performance specifications, functions, and external dimensions of the base units due to the change.

1 RELEVANT MODELS

Product	Model
FX5S CPU module	FX5S-30MR/ES, FX5S-30MT/ES, FX5S-30MT/ESS, FX5S-40MR/ES, FX5S-40MT/ES, FX5S-40MT/ESS, FX5S-60MR/ES, FX5S-60MT/ES, FX5S-60MT/ESS

2 DETAILS ON THE CHANGE

The size and internal buffering structure of packaging box will be changed as follows.

Item		Before change	After change
External dimensions of packaging box	30 points	166 (W) × 162 (D) × 114 (H) [mm]	156 (W) × 152 (D) × 114 (H) [mm]
	40 points	196 (W) × 162 (D) × 114 (H) [mm]	186 (W) × 152 (D) × 114 (H) [mm]
	60 points	242 (W) × 162 (D) × 114 (H) [mm]	232 (W) × 152 (D) × 114 (H) [mm]
Form of packaging box			

3 REASON FOR THE CHANGE

To reduce loads on the environment.

4 SCHEDULE

The change will be applied to products manufactured on and after February 2023.

Note that, depending on stock status, both products with packaging before and after change may be distributed in the market around that time.

REVISIONS

Version	Date of Issue	Revision
A	February 2023	First edition

TRADEMARKS

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